| | - 1 | · | 5 6 7 8 |
|---|--|----------------------|--|
| HARTING | DIN power male c | onnector - SMC | Soldering instructions Soldering instructions |
| | | | The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating. |
| General information | | | (1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the undersi |
| | | | of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of to soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice. |
| Design | IEC 60603-2 | types: F male | (2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking device shields the connectors from gas and |
| No. of contacts | max. 48 | | heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered. |
| Contact spacing | 5,08 mm | | |
| Test voltage | 1550V contact/contact | 2500V contact/ground | Quantity of solder paste |
| Contact resistance | max. 15m0hm | | |
| Insulation resistance | min. 10º20hm | , | Before the components are assembled, solder paste must be applied to all the solder pads (for connecting surface-mount components) and the |
| Working current | max. 6A at 20°C (see derating diagram | | plated through holes. |
| Temperature range | _55°C +125°C max. 15s at 240°C | for reflow soldering | To ensure that the plated through holes are completely filled, significantly more solder paste must be applied than traditional solder pads on |
| Termination technology | SMC (Surface Mount Compatible) with | solder pins | pcb surface. There are numerous calculation methods available which are complicated to apply. The following rule of thumb has proved valuable practice: |
| Clearance | min. 1,6 mm | | |
| Сгеераде | min. 3,0 mm | | VPaste = 2(VH - VP) in which: |
| Insertion and withdrawal force | 75N | | In which: VPaste = Required volume of solder paste |
| | - PL1 acc. to IEC 60603-2 => | 500 mating cycles | VH = Volume of the plated through hole |
| Mating cycles | - PL2 acc. to IEC 60603-2 => | 400 mating cycles | VP = Volume of the connector termination in the hole |
| | - PL3 acc. to IEC 60603-2 => | 50 mating cycles | Comment: the multiplier "2" compensates for solder paste shrinkage during soldering. For this purpose, it was assumed that 50 % of the paste |
| UL file | E102079 | | consists of the actual solder, the other 50 % being soldering aids. |
| RoHS – compliant | Yes | | |
| Leadfree | Yes | | Cross section of solder pins |
| Hot plugging | No | | , pol |
| | | | 0,29 - 0,34 mm ² |
| Insulator material | | | |
| | | | |
| Material | PCT (thermoplastics, glass fiber reinf | | |
| Colour | natural-colored, color deviations and | speckles permitted | |
| UL classification | UL 94-V0 | | 0,53±0,03 |
| Material group acc. to IEC 60664-1 | II (400 <u><</u> CTI < 600) | | |
| NFF classification | 13, F3 | | |
| | | | |
| Contact material | | | |
| | | | |
| Contact material | Copper alloy | | |
| Plating termination zone | Sn over Ni | | |
| Plating contact zone | Au over PdNi over Ni | | |
| Derating diagram acc. to IEC 60512-5 (Cur | ent carrying capacity) | | |
| The current commission of the current | maximum | ^ | |
| The current carrying capacity is limited by temperature of materials for inserts and | | A 6 N | |
| terminals. | - | \equiv $ $ | |
| The current capacity curve is valid for co interrupted current loaded contacts of co | ntinuous, non nnectors when | [V peo] 4 | |
| simultaneous power on all contacts is give | | 9 4 | All Dimensions in mm Scale Free size tol. Ref. |
| the maximum temperature. Control and test procedures according to DIN IEC 60512-5 | | | All Dimensions in mm |
| | | | |
| | | <u>u</u> 2 | HAGEMEYERE TAD IF HOFFMANN 2014-09-12 Final Release |
| | | 1 | Menartment sc pp. ps. |
| | | 1 | DIN power male connector - SMC 100580651/UG |
| | | 0 20 40 60 80 100 | TIANTING ELECTIONES GIIDH |
| | | | 120 °C D-32339 Espelkamp Type DS Number 09061230201 |
| | | Temperature [°C] | 120 °C D-32339 Espelkamp Type DS Number 09061230201 |

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